



HM1730800000G Information

Heisener.com

Part NumberHM1730800000GManufacturerAmphenol Anytek

Category Connectors, Interconnects

Terminal Blocks - Wire to Board

Description 381 TB SP CLA DIP SOLDER

Package -

For the pricing/inventory/lead time, please contact

us

For Reference Only

Website: https://www.heisener.com
E-mail: salesdept@heisener.com



Request a Quote

Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.









HM1730800000G Specifications

Manufacturer Part Number	HM1730800000G
Manufacturer	Amphenol Anytek
Category	Connectors, Interconnects
	Terminal Blocks - Wire to Board
Package	-
Series	HM
Number of Levels	1
Positions Per Level	17
Pitch	0.150" (3.81mm)
Mating Orientation	Vertical with Board
Current	8A
Voltage	300V
Wire Gauge	14-28 AWG
Mounting Type	Through Hole
Wire Termination	Screwless - Leg Spring, Push-In Spring
Features	Interlocking (Side)
Color	Gray
	Report errors?

HM1730800000G Guarantees



Quality Guarantees

We provide 90 days warranty. *

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



Service Guarantees

We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

HM1730800000G Payment Methods



















HM1730800000G Shipping Methods













If you have any question about HM1730800000G, please do not hesitate to contact us!

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